



Unison Industries Forced Air-Cooled Heat Sink



Dustin Birchall, Tyler Pilet, and Jeffery Rutledge
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Team 19



Dustin Birchall
Lead ME



Parker Harding
Team Leader



Tyler Pilet
Lead FEA Engineer



Lucas Pye
Recorder



Jeffery Rutledge
Financial Advisor



Project Recap

Dustin Birchall



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Project Recap

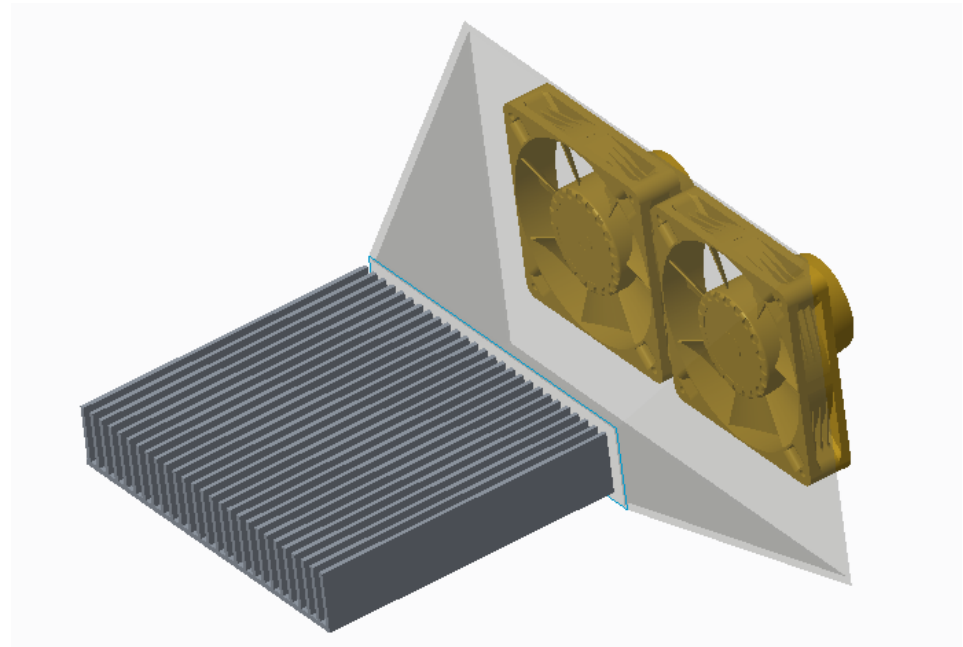
- Team 19 is tasked with developing a forced air, lightweight heat sink that must be able to dissipate 300W of heat and maintain a temperature of 135°C max (preferably lower).
- A full-bridge rectifier, which changes AC to DC, is our heat source. It is necessary to cool this device, as overheating results in electrical failure for the aircraft.
- Objectives:
 - Design and construct a Heatsink to keep the aircraft's circuitry below an operating temperature of 135°C
 - Lightweight
 - Physically small in size
 - Remove Heat
 - Minimize use of our \$2000 budget
 - Efficiently organize 24 Semiconductors in sets divisible by 3

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Old Design

- Where we left off with Design Review 3
- Ideas that were certain:
 - Duct
 - 2 Fans
 - Rectangular Fins
- Possible ideas:
 - Graphite plate
- Find a way to mount fans

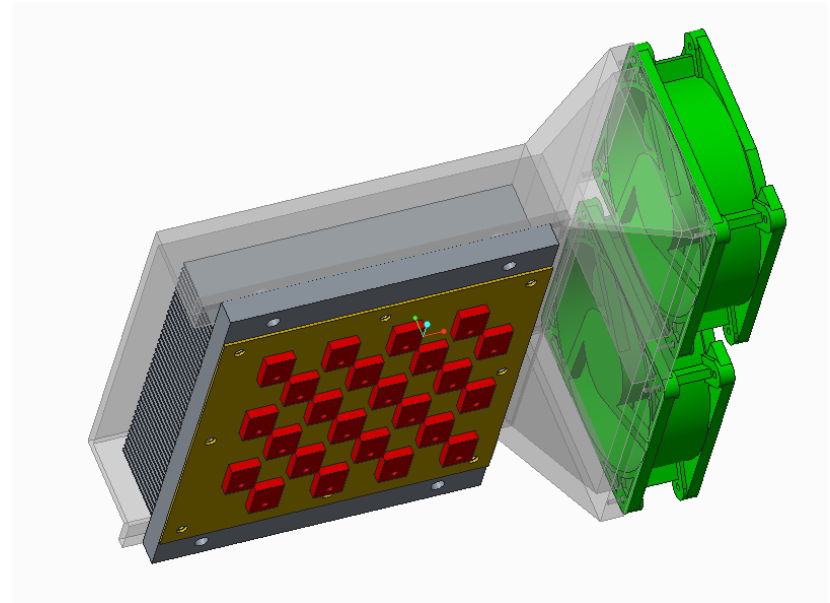
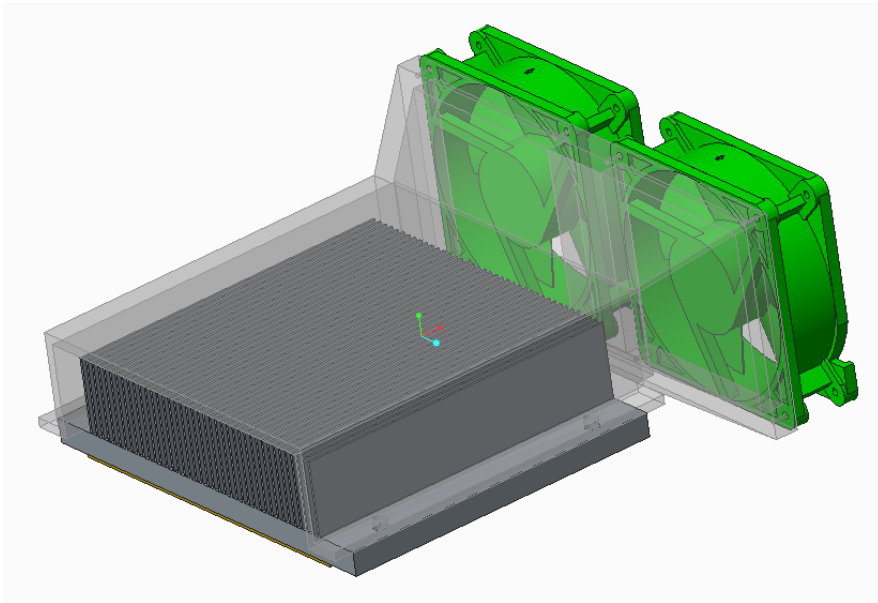


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Updated Design



- A duct forcing air through entire length of channels of the heatsink.
- Graphite plate to help distribute heat evenly.

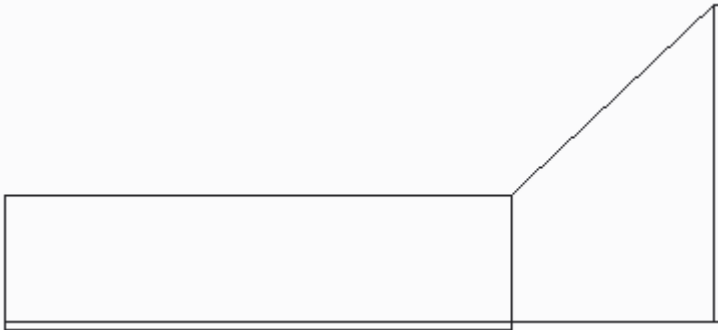
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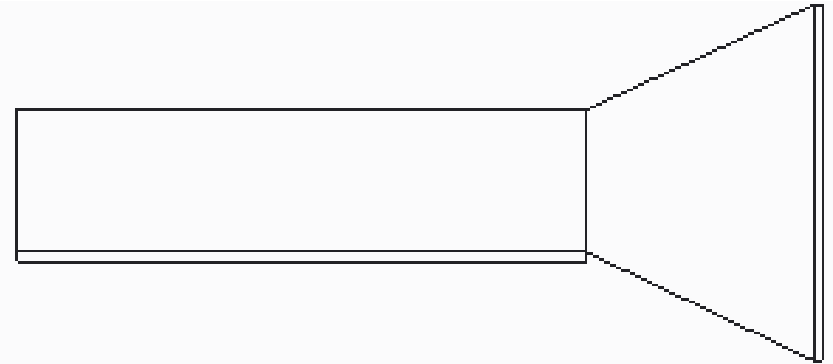
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Issues

- When we attempted to order our updated design, we were told of ways to make some of the parts cheaper and easier to fabricate.
- For our heatsink fin dimensions, we originally had a spacing of .133 in.
 - We changed the dimension to be .125 in, a standard size
 - Saved a couple hundred dollars
- Next for the duct, we had to alter how it constrained the air,
 - We were told by Parker Services that they fabricate the ducts a certain way so we altered our design so that they could easily make ours.



Updated duct design

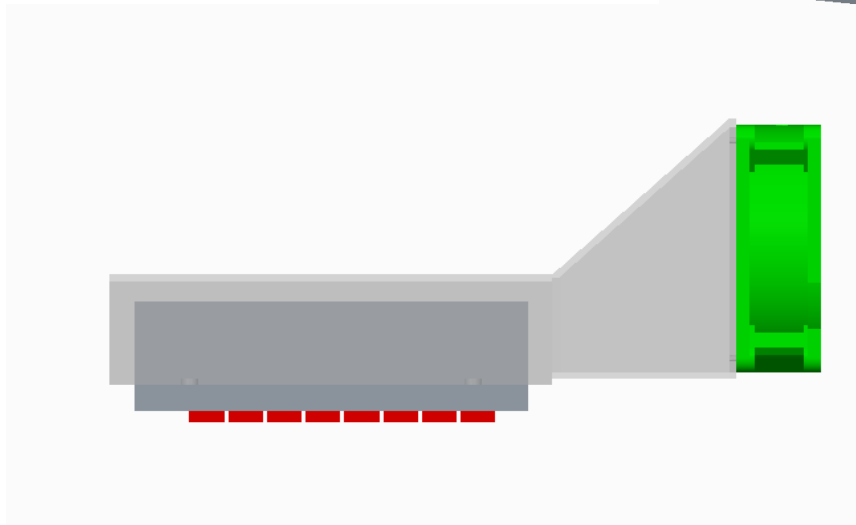
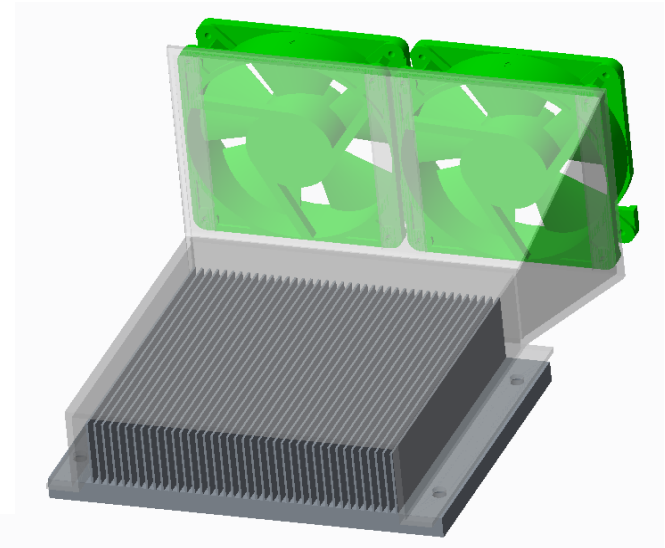
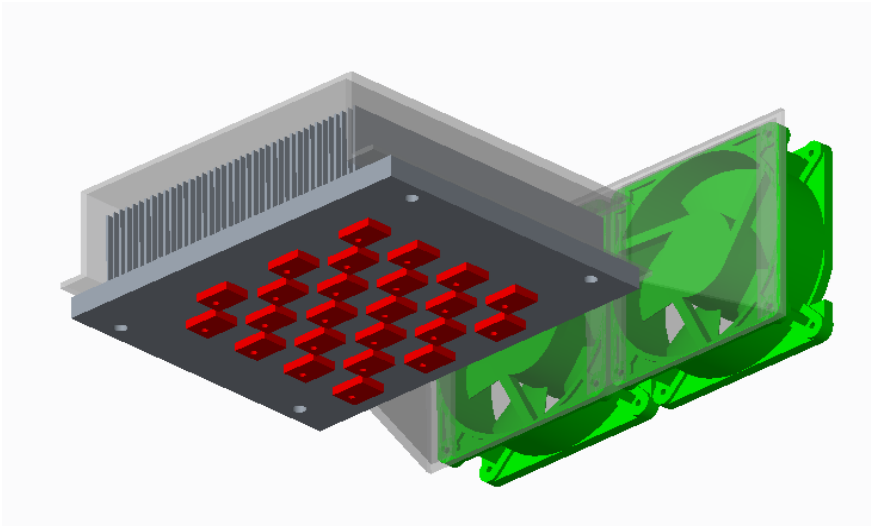


Old duct design

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Finalized Design



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Ordering

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Aquisitions

- Allied Electronics
 - 30 resistors to act as semiconductors
- Parker Services
 - Sheet metal for fan duct
- Already in Possession
 - Wiring for resistors and fans
 - Screws for resistors
 - Thermal camera
- Ordered
 - 2 Heat Sinks
- To be Ordered
 - 2 Fans
 - ~30 Thermal pads



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Mersen

CURRENCY		TERMS				SHIPPING TERMS	
USD		Cash-In-Advance				Freight Pre-pay and Add	
Line #	Mersen Part #	Description	Customer Part #		QTY	UoM	UNIT PRICE(EA)
1	QUOTEITEM	MF178T13A53AF40D			1	EA	329.67
					3	EA	217.58
					5	EA	217.58

Mersen Quote

PROS:

- R-Theta tool
- Cheap price
- Many designs to choose from

CONS:

- Lead Time: 10 weeks
- Not customizable
- Difficult to mount fan duct onto design

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COE Machine Shop

- COE Machine Shop
 - Unable to cut the fins
 - Possibly buy new tool to machine it



New Tool: End Mill

- Problems with Machining
 - New tool would break easily
 - Long time to machine the heatsink
 - Machinist didn't want to machine it

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Velocity Machine Works

- Velocity Machine Works
 - Can make our heatsink
 - Came up with a new fin dimensions to 1/8 inches
 - Lead time: 1 month
 - PO Made by Neil Coker

Terms Net 30		F.O.B. Tallahassee		Delivery 3 weeks	Valid thru 3/02/2018	
Quantity	Runs	Part Number	Rev	Description	Price/Unit	Extension
1	1	Heatsink	1	Heatsink	1,396.88	1,396.88
3	1	Heatsink	1	Heatsink	1,173.96	3,521.88
1	1	Heatsink 3.175		Heatsink 3.175	959.38	959.38
3	1	Heatsink 3.175		Heatsink 3.175	736.46	2,209.38
						8,694.08

First revision of Quote

Terms Net 30		F.O.B. Tallahassee		Delivery 45 Days ARO	Valid thru 3/03/2018	
Quantity	Runs	Part Number	Rev	Description	Price/Unit	Extension
2	1	Heatsink 3.175		Heatsink 3.175	792.19	1,584.38
						1,584.38

Second revision of Quote

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Budget

- Total Budget: \$2,000
- Current running total spent: \$1,783.42
- Current running total left: \$216.58
- What is left to price:
 - Thermal pads: ~\$50.00

Budget for Team 19

Website	Purchase	Quantity	Cost	Running Total Cost	Running Total Budget
https://www.alliedelec.com/caddock-mp915-20-0-1-/70089556/	Resistors	30	\$52.20	\$52.20	\$1,947.80
https://www.mcmaster.com/#fans/=1bdtg5n	Fans	2	\$146.84	\$199.04	\$1,800.96
https://www.velocitymachineworks.com/	Machine Work	2	\$1,584.38	\$1,783.42	\$216.58

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Future Work

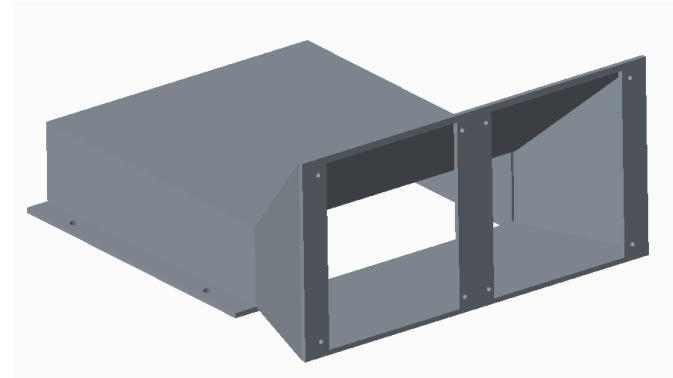
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Future Work

- A duct was required, as the fans are larger than our heat sink's height. The flow needed to be guided through the fins.
- Parker Services, Lucas's employer, donated sheet metal and equipment to produce a duct for our team.
- The duct will be manufactured after fans are received. The lead time a singular day.



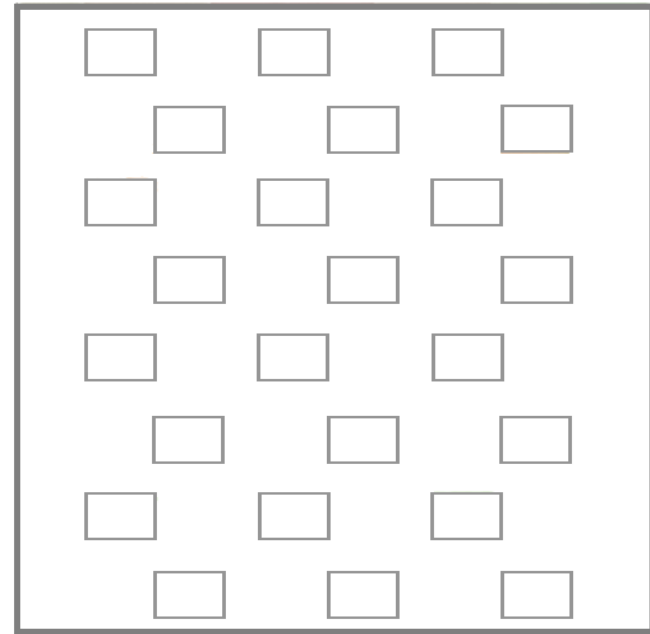
A CAD model of our proposed duct.

Tyler Pilet



Testing and Optimization

- In order to determine the resistance and voltage needed, $V = I \cdot R$ and $P = I \cdot V$ were combined and rearranged to produce $V = (P \cdot R)^{0.5}$
- The 12.5 W heat dissipation of the semiconductors will be simulated by 20 ohm resistors run at 15.8 VDC.
- The 24 resistors will be placed in a staggered pattern.



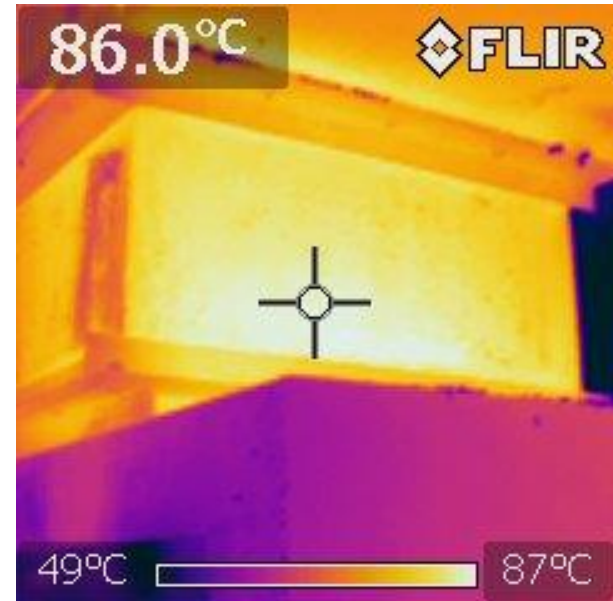
A drawing displaying the semiconductor locations.

Tyler Pilet



Testing and Optimization (Cont.)

- The experiment will take place at room temperature.
- Once the system reaches steady-state temperatures, the ambient temperature will be recorded with a thermistor and thermal imaging camera will be used to determine cold spot on the fins.
- k-Type thermocouple pads will be used to verify the thermal image, inlet, and outlet conditions.
- Using the thermal image, cold spots on fins will be determined, and material will be milled off to reduce weight.



A sample thermal image taken last month with Dr. Juan Ordonez.

Tyler Pilet



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QUESTIONS?

